



PDR5KF

# 5A GLASS PASSIVATED FAST RECOVERY RECTIFIER POWERDI5

### Product Summary (@T<sub>A</sub> = +25°C)

| V <sub>RRM</sub> (V) | I <sub>O</sub> (A) | V <sub>F</sub> Max (V) | I <sub>R</sub> Max (μA) |
|----------------------|--------------------|------------------------|-------------------------|
| 800                  | 5                  | 1.2                    | 10                      |

#### **Features and Benefits**

- Glass Passivated Die Construction for High Reliability
- Low Leakage Current Saves Power in Battery-Powered Applications
- Fast Reverse Recovery Speed provides High Efficiency in Switching Applications
- Large Exposed Heat Sink on Device Underside Provides Good Heat-Sinking to Support High Power Dissipation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Description**

PDR5KF, a 5.0A Glass Passivated Rectifier in our thermally efficient PowerDI<sup>®</sup>5 package, offers high-surge current capability, low-leakage current and fast reverse recovery time.

### **Mechanical Data**

- Case: POWERDI<sup>®</sup>5
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 63
- Polarity: See Diagram
- Weight: 0.096 grams (Approximate)







**Bottom View** 



Note: Pins Left & Right must be electrically connected at the printed circuit board.

#### **Ordering Information** (Note 4)

| Part Number | Compliance | Case                   | Packaging         |
|-------------|------------|------------------------|-------------------|
| PDR5KF-13   | Commercial | POWERDI <sup>®</sup> 5 | 5,000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



R5KF = Product Type Marking Code

| Strict = Manufacturers' Code Marking
| YYWW = Date Code Marking
| YY = Last Two Digits of Year (ex: 15 for 2015)
| WW = Week Code (01 to 53)
| K = Factory Designator



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic                                                                                      | Symbol                                                 | Value | Unit     |
|-----------------------------------------------------------------------------------------------------|--------------------------------------------------------|-------|----------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage              | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 800   | <b>V</b> |
| Average Rectified Output Current                                                                    | lo                                                     | 5     | А        |
| Peak Repetitive Reverse Surge Voltage (Note 5)                                                      | $V_{RSM}$                                              | 1,050 | V        |
| Non-Repetitive Peak Forward Surge Current<br>8.3ms Single Half Sine-Wave Superimposed on Rated Load | I <sub>FSM</sub>                                       | 250   | А        |

### **Thermal Characteristics**

| Characteristic                                          | Symbol                            | Value       | Unit |
|---------------------------------------------------------|-----------------------------------|-------------|------|
| Typical Thermal Resistance Junction to Lead (Note 7)    | $R_{	hetaJL}$                     | 2.2         | °C/W |
| Typical Thermal Resistance Junction to Lead (Note 6)    | $R_{	heta JL}$                    | 9.5         | °C/W |
| Typical Thermal Resistance Junction to Ambient (Note 7) | $R_{	heta JA}$                    | 24.5        | °C/W |
| Typical Thermal Resistance Junction to Ambient (Note 6) | $R_{	hetaJA}$                     | 77          | °C/W |
| Operating and Storage Temperature Range                 | T <sub>J</sub> , T <sub>STG</sub> | -65 to +150 | °C   |

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

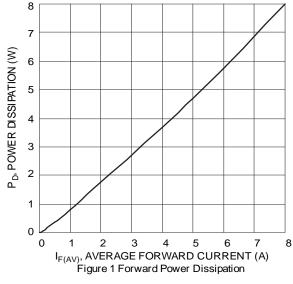
| Characteristic                     | Symbol          | Min | Тур           | Max       | Unit | Test Condition                                            |
|------------------------------------|-----------------|-----|---------------|-----------|------|-----------------------------------------------------------|
| Reverse Breakdown Voltage (Note 8) | $V_{(BR)R}$     | 800 |               |           | V    | $I_R = 10\mu A$                                           |
| Forward Voltage                    | VF              |     | 0.95          | 1.2       | V    | I <sub>F</sub> = 5A, T <sub>S</sub> = +25°C               |
| Reverse Leakage Current (Note 8)   | I <sub>R</sub>  |     | 0.06<br>0.006 | 10<br>0.3 |      | $V_R = 800V, T_J = +25$ °C<br>$V_R = 800V, T_J = +125$ °C |
| Reverse Recovery Time              | t <sub>RR</sub> | _   | 300           | 500       |      | $I_F = 0.5A, I_R = 1.0A,$<br>$I_{RR} = 0.25A$             |

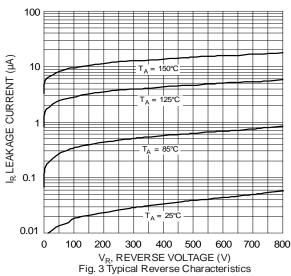
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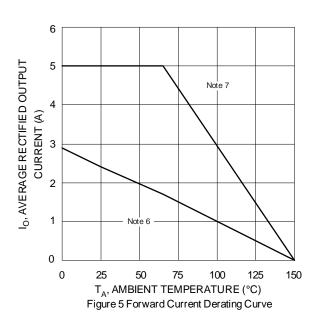
- 5. Per IEC61000-4-5 surge standard, 1.2/50µs voltage impulse, 20hm source impedance, 8x20µs surge current.
- Device mounted on FR-4 PC board, 202 copper trace weight, with 1x recommended pad layout. Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest revision.
   Device mounted on 2 inch by 2 inch Alumina substrate PC board.
   Short duration pulse test used to minimize the self-heating effect.

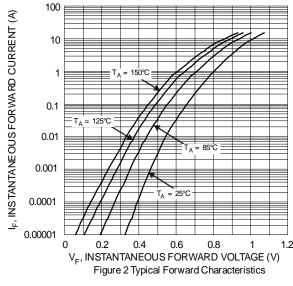
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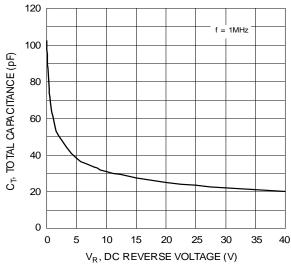


Fig. 4 Total Capacitance vs. Reverse Voltage

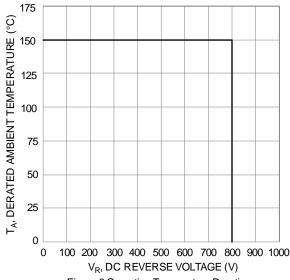
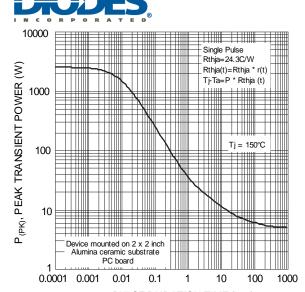


Figure 6 Operating Temperature Derating

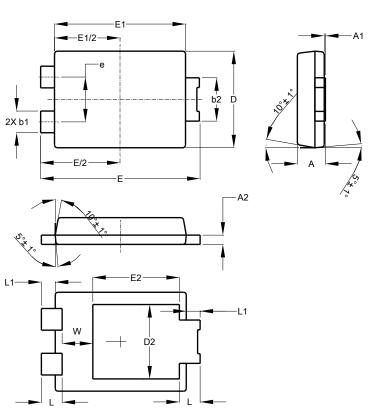


 $t_{1}, {\tt PULSE\ DURATION\ TIME\ (sec)}$  Figure 7 Single Pulse Maximum Power Dissipation

### **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

# POWERDI®5

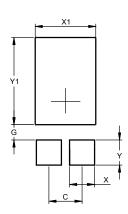


| POWERDI <sup>®</sup> 5 |      |      |       |  |
|------------------------|------|------|-------|--|
| Dim                    | Min  | Max  | Тур   |  |
| Α                      | 1.05 | 1.15 | 1.10  |  |
| A1                     | 0.00 | 0.05 |       |  |
| A2                     | 0.33 | 0.43 | 0.381 |  |
| b1                     | 0.80 | 0.99 | 0.89  |  |
| b2                     | 1.70 | 1.88 | 1.78  |  |
| D                      | 3.90 | 4.05 | 3.966 |  |
| D2                     | -    | -    | 3.054 |  |
| Е                      | 6.40 | 6.60 | 6.504 |  |
| е                      | -    | -    | 1.84  |  |
| E1                     | 5.30 | 5.45 | 5.37  |  |
| E2                     | -    | ı    | 3.549 |  |
| L                      | 0.75 | 0.95 | 0.85  |  |
| L1                     | 0.50 | 0.65 | 0.57  |  |
| W                      | 1.10 | 1.41 | 1.255 |  |
| All Dimensions in mm   |      |      |       |  |



### Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



#### POWERDI<sup>®</sup>5

| Dimensions | Value (in mm) |  |  |
|------------|---------------|--|--|
| С          | 1.840         |  |  |
| G          | 0.852         |  |  |
| Х          | 1.390         |  |  |
| X1         | 3.360         |  |  |
| Y          | 1.400         |  |  |
| Y1         | 4.860         |  |  |

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